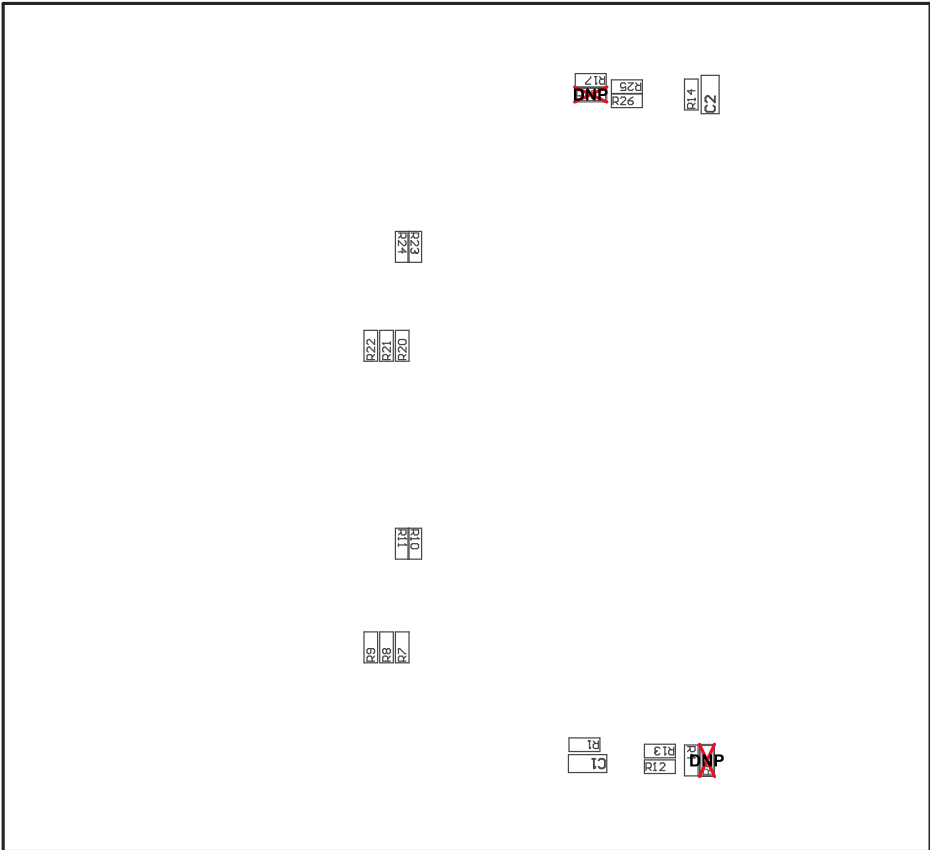


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT: 001

|                                  |                                   |                   |                                |
|----------------------------------|-----------------------------------|-------------------|--------------------------------|
| PCB VIEWED FROM TOP SIDE         | BOARD #: PMP20249                 | REV: A            | SUN REV: Not In VersionControl |
|                                  | TID #: N/A                        |                   |                                |
| PLOT NAME = Top Assembly Drawing | GENERATED : 11/15/2016 9:45:49 AM | TEXAS INSTRUMENTS |                                |



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT: 001

|                                     |                                   |        |                                |
|-------------------------------------|-----------------------------------|--------|--------------------------------|
| PCB VIEWED FROM BOTTOM SIDE         | BOARD #: PMP20249                 | REV: A | SUN REV: Not In VersionControl |
|                                     | TID #: N/A                        |        |                                |
| PLOT NAME = Bottom Assembly Drawing | GENERATED : 11/15/2016 9:45:50 AM |        | TEXAS INSTRUMENTS              |

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